

CMOS Digital Integrated Circuits Silicon Monolithic

74HC240D,74HC244D

1. Functional Description

· Octal Bus Buffer

74HC240D: INVERTED, 3-STATE OUTPUTS 74HC244D: NON-INVERTED, 3-STATE OUTPUTS

2. General

The 74HC240D and 74HC244D are high speed CMOS OCTAL BUS BUFFERs fabricated with silicon gate C2MOS technology.

They achieve the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

The 74HC240D is an inverting 3-state buffer and the 74HC244D are non-inverting 3-state buffers having two active-low output enables.

These devices are designed to be used with 3-state memory address drivers, etc.

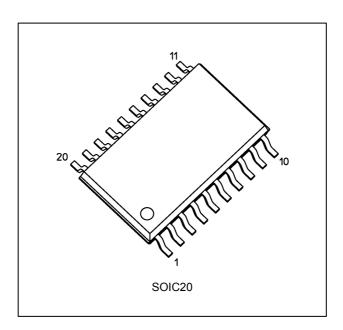
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

3. Features

- (1) Wide operating temperature range: $T_{opr} = -40$ to 125 °C (Note 1)
- (2) High speed: $t_{pd} = 10 \text{ ns (typ.)}$ at $V_{CC} = 6.0 \text{ V}$
- (3) Low power dissipation: $I_{CC} = 4.0 \mu A \text{ (max)}$ at $T_a = 25 \text{ °C}$
- (4) Balanced propagation delays: $t_{PLH} \approx t_{PHL}$
- (5) Wide operating voltage range: $V_{CC(opr)} = 2.0 \text{ V}$ to 6.0 V

Note1 1:Operating Range spec of T_{opr} = -40 °C to 125 °C is applicable only for the products which manufactured after July 2020.

4. Packaging

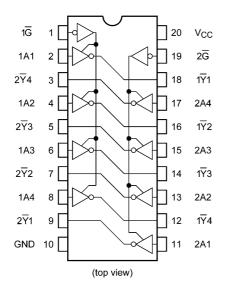


Start of commercial production

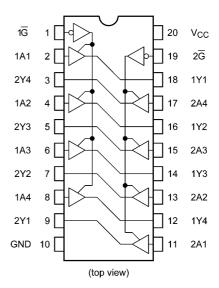


5. Pin Assignment

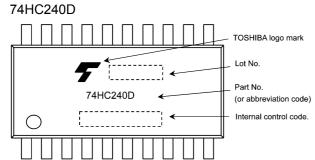
74HC240D



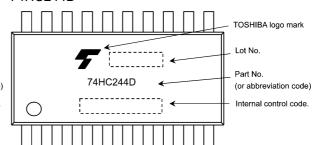
74HC244D



6. Marking

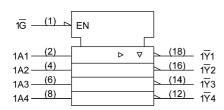


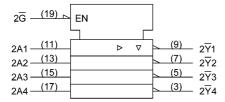




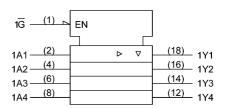
7. IEC Logic Symbol

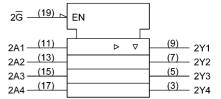
74HC240D





74HC244D







8. Truth Table

Input G	Input An	Output Yn	Output \overline{Y} n
L	L	L	Н
L	Н	Н	L
Н	Х	Z	Z

X: Don't care
Z: High impedance
Yn: 74HC244D
7n: 74HC240D

9. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V _{CC}		-0.5 to 7.0	V
Input voltage	V _{IN}		-0.5 to V _{CC} + 0.5	V
Output voltage	V _{OUT}		-0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}		±20	mA
Output diode current	lok		±20	mA
Output current	l _{out}		±35	mA
V _{CC} /ground current	I _{CC}		±75	mA
Power dissipation	P_D	(Note 1)	500	mW
Storage temperature	T _{stg}		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: PD derates linearly with -8 mW/°C above 85 °C

10. Operating Ranges (Note)

Characteristics	Symbol	Test Condition	Note	Rating	Unit
Supply voltage	V _{CC}			2.0 to 6.0	V
Input voltage	V_{IN}			0 to V _{CC}	V
Output voltage	V _{OUT}			0 to V _{CC}	٧
Operating temperature	T _{opr}		(Note 1)	-40 to 125	°C
Input rise and fall times	t_r, t_f	V _{CC} = 2.0 V		0 to 1000	ns
		V _{CC} = 4.5 V		0 to 500	
		V _{CC} = 6.0 V		0 to 400	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

Note 1: Operating Range spec of T_{opr} = -40 °C to 125 °C is applicable only for the products which manufactured after July 2020.



11. Electrical Characteristics

11.1. DC Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Min	Тур.	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50	_	_	V
				4.5	3.15	_	_]
				6.0	4.20	_	_	
Low-level input voltage	V _{IL}	_		2.0	_	_	0.50	V
				4.5			1.35	
				6.0			1.80	
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -20 μA	2.0	1.9	2.0	_	V
				4.5	4.4	4.5	_	
				6.0	5.9	6.0	_	
			I_{OH} = -6 mA	4.5	4.18	4.31	_	
			I _{OH} = -7.8 mA	6.0	5.68	5.80	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 20 μA	2.0		0.0	0.1	V
				4.5	_	0.0	0.1	
				6.0	_	0.0	0.1	
			I _{OL} = 6 mA	4.5		0.17	0.26	
			I _{OL} = 7.8 mA	6.0		0.18	0.26	
3-state output OFF-state leakage current	l _{OZ}	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or GND}$		6.0	_	ı	±0.5	μА
Input leakage current	I _{IN}	$V_{IN} = V_{CC}$ or GND		6.0		_	±0.1	μА
Quiescent supply current	I _{CC}	$V_{IN} = V_{CC}$ or GND		6.0	_		4.0	μА

11.2. DC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Min	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50	_	V
				4.5	3.15	_	1
				6.0	4.20	_	
Low-level input voltage	V _{IL}	_		2.0		0.50	V
				4.5		1.35	
				6.0		1.80	
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -20 μA	2.0	1.9		V
				4.5	4.4	_	
				6.0	5.9	_	
			I_{OH} = -6 mA	4.5	4.13	_	
			$I_{OH} = -7.8 \text{ mA}$	6.0	5.63	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 20 μA	2.0		0.1	V
				4.5	ı	0.1	
				6.0		0.1	
			I _{OL} = 6 mA	4.5		0.33	
			I _{OL} = 7.8 mA	6.0		0.33	
3-state output OFF-state leakage current	I _{OZ}	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or GND}$		6.0	_	±5.0	μА
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND		6.0		±1.0	μА
Quiescent supply current	I _{CC}	$V_{IN} = V_{CC}$ or GND		6.0	_	40.0	μА



11.3. DC Characteristics (Note) (Unless otherwise specified, T_a = -40 to 125 °C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Min	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50	_	V
				4.5	3.15	_	
				6.0	4.20	_]
Low-level input voltage	V _{IL}	_		2.0	_	0.50	V
				4.5	_	1.35	
				6.0	_	1.80]
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -20 μA	2.0	1.9	_	V
				4.5	4.4	_	
				6.0	5.9	_]
			I _{OH} = -6 mA	4.5	3.7	_	
			I _{OH} = -7.8 mA	6.0	5.2	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 20 μA	2.0	_	0.1	V
				4.5	_	0.1]
				6.0	_	0.1]
			I _{OL} = 6 mA	4.5	_	0.4	
			I _{OL} = 7.8 mA	6.0	_	0.4	
3-state output OFF-state leakage current	I _{OZ}	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or GND}$		6.0	_	±5.0	μА
Input leakage current	I _{IN}	$V_{IN} = V_{CC}$ or GND		6.0	_	±1.0	μА
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or GND		6.0	_	80.0	μА

Note: Operating Range spec of T_{opr} = -40 °C to 125 °C is applicable only for the products which manufactured after July 2020.



11.4. AC Characteristics (Unless otherwise specified, T_a = 25 °C, Input: t_r = t_f = 6 ns)

Characteristics	Part Number	Symbol	Note	Test Condition	C _L (pF)	V _{CC} (V)	Min	Тур.	Max	Unit
Output transition time		t _{TLH} ,t _{THL}			50	2.0	1	25	60	ns
						4.5		7	12	
						6.0		6	10	
Propagation delay time		t_{PLH}, t_{PHL}			50	2.0		36	90	ns
						4.5		12	18	
						6.0		10	15	
					150	2.0		51	130	
						4.5		17	26	
						6.0		14	22	
Output enable time		t_{PZL}, t_{PZH}		$R_L = 1 k\Omega$	50	2.0	_	48	125	ns
						4.5	_	16	25	
						6.0		14	21	
					150	2.0	_	63	165	
						4.5	_	21	33	
						6.0	_	18	28	
Output disable time		t_{PLZ}, t_{PHZ}		$R_L = 1 k\Omega$	50	2.0	_	32	125	ns
						4.5	_	15	25	
						6.0	_	14	21	
Input capacitance		C _{IN}		_				5	10	pF
Output capacitance		C _{OUT}		_				10	_	pF
Power dissipation	74HC240D	C _{PD}	(Note 1)	_				31	_	pF
capacitance	74HC244D						_	33	_	

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation. $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{|N} + I_{CC}/8 \text{ (per bit)}$

11.5. AC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C, Input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition	C _L (pF)	V _{CC} (V)	Min	Max	Unit
Output transition time	t _{TLH} ,t _{THL}	_	50	2.0	_	75	ns
				4.5	_	15	
				6.0	_	13]
Propagation delay time	t _{PLH} ,t _{PHL}	_	50	2.0	_	115	ns
				4.5	_	23	
				6.0	_	20	
			150	2.0	_	165	
				4.5	_	33	
				6.0	_	28]
Output enable time	t _{PZL} ,t _{PZH}	$R_L = 1 k\Omega$	50	2.0	_	155	ns
				4.5	_	31	
				6.0	_	26]
			150	2.0	_	205	
				4.5	_	41	
				6.0	_	35]
Output disable time	t _{PLZ} ,t _{PHZ}	$R_L = 1 k\Omega$	50	2.0	_	155	ns
				4.5	_	31]
				6.0	_	26	
Input capacitance	C _{IN}	_			_	10	pF



11.6. AC Characteristics (Note) (Unless otherwise specified, T_a = -40 to 125 °C, Input: t_r = t_f = 6 ns)

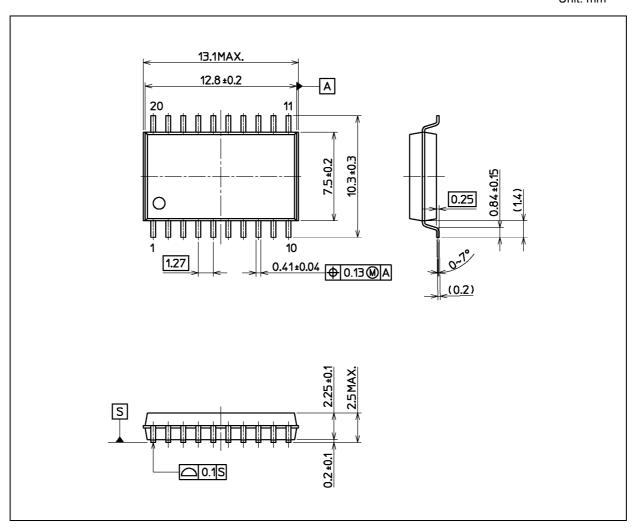
Characteristics	Symbol	Test Condition	C _L (pF)	V _{CC} (V)	Min	Max	Unit
Output transition time	t _{TLH} ,t _{THL}	_	50	2.0	_	85	ns
				4.5	_	17	
				6.0	_	15]
Propagation delay time	t _{PLH} ,t _{PHL}	_	50	2.0	_	135	ns
				4.5	_	27	
				6.0	_	24]
			150	2.0	_	190	
				4.5	_	38	
				6.0	_	32]
Output enable time	t_{PZL}, t_{PZH}	$R_L = 1 k\Omega$	50	2.0	_	175	ns
				4.5	_	35	
				6.0	_	30]
			150	2.0	_	235	
				4.5	_	47	
				6.0	_	40]
Output disable time	t_{PLZ}, t_{PHZ}	$R_L = 1 k\Omega$	50	2.0	_	175	ns
				4.5	_	35]
				6.0	_	30	1
Input capacitance	C _{IN}	_		•	_	10	pF

Note: Operating Range spec of T_{opr} = -40 °C to 125 °C is applicable only for the products which manufactured after July 2020.



Package Dimensions

Unit: mm



Weight: 0.51 g (typ.)

	Package Name(s)
Nickname: SOIC20	



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